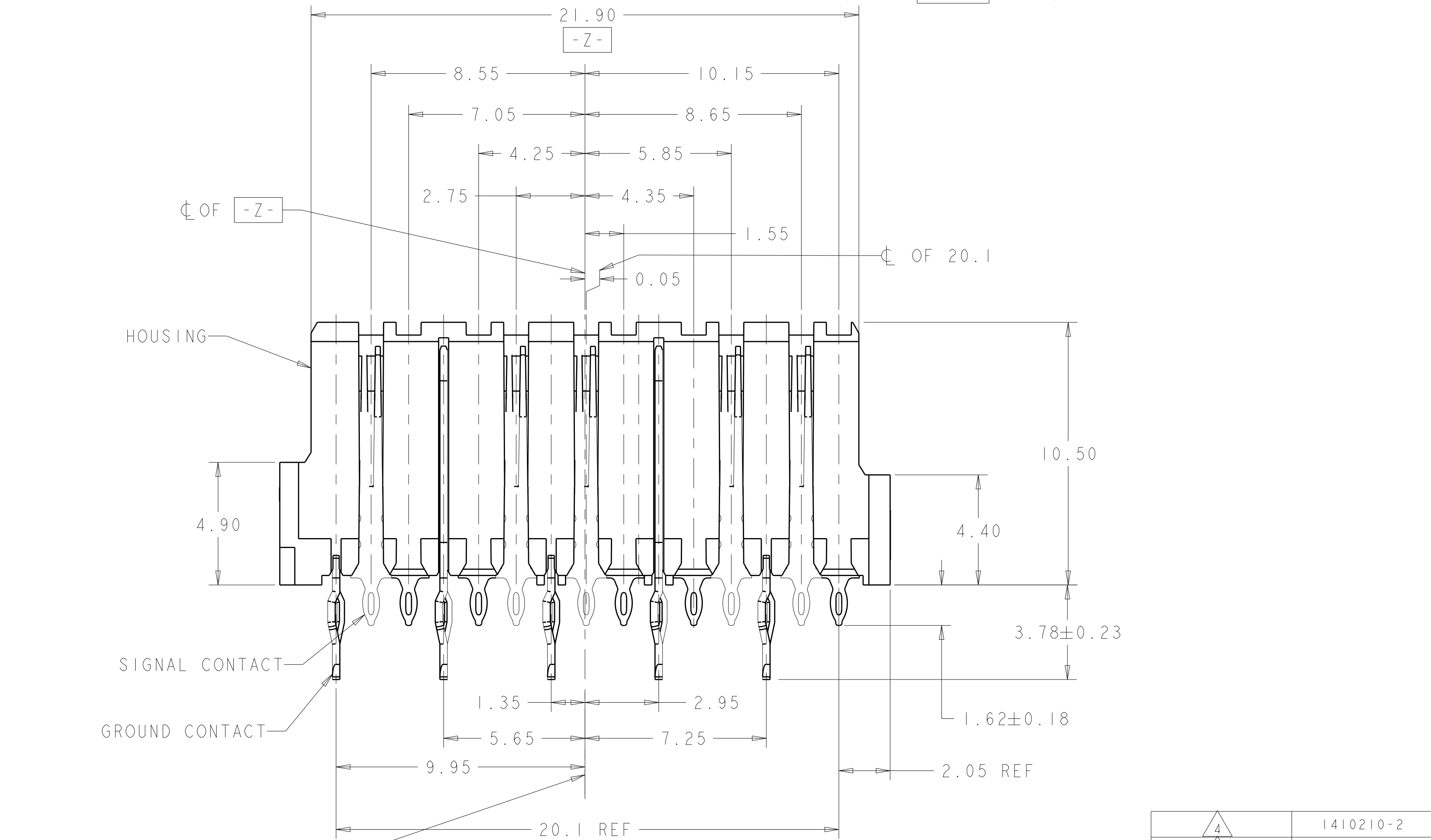
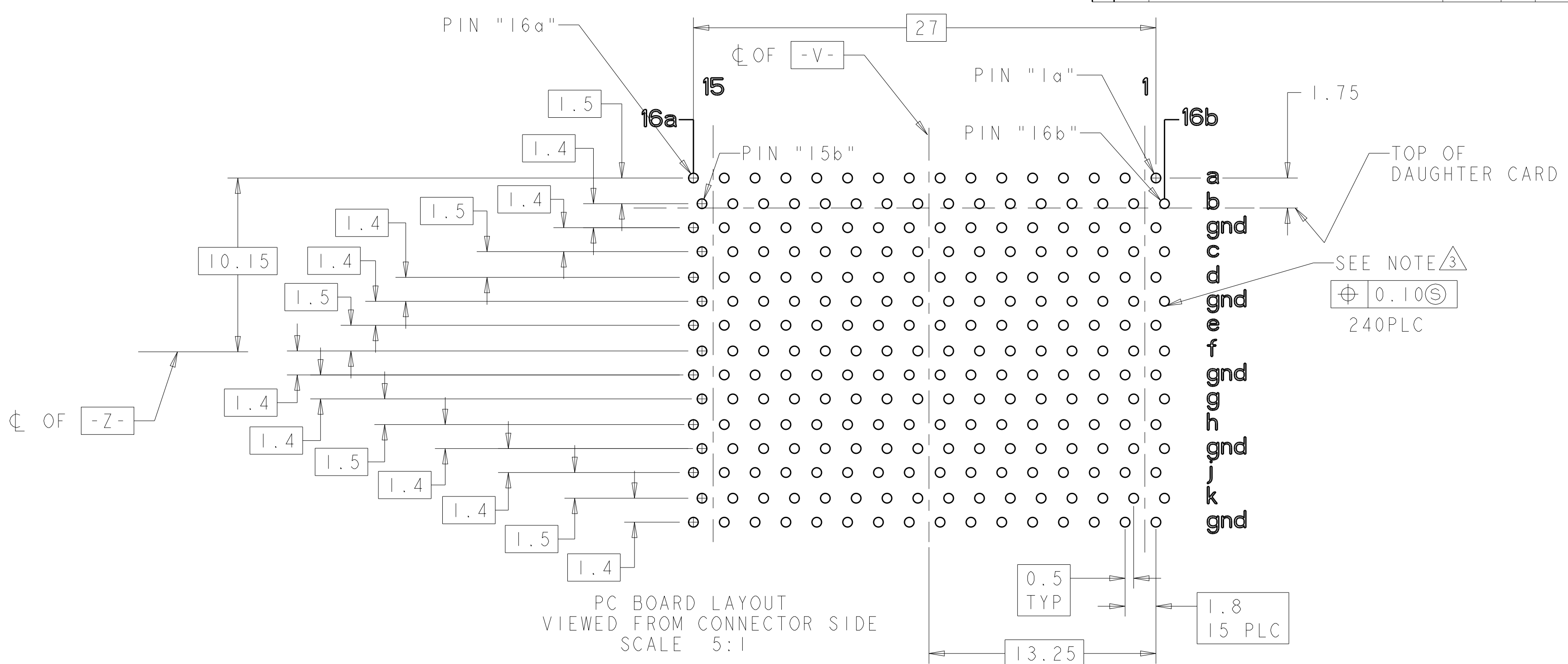




①	HOUSING: LCP, UL94V-0, BLACK. CONTACT: PHOSPHOR BRONZE.	 1.10 REF
②	1.27 μ m GOLD PER ASTM B 488 IN CONTACT AREA, 1.27 μ m MIN TIN-LEAD ON PCB TAIL, OVER 3.81 μ m MIN NICKEL PER SAE AMS-QQ-N-290 OVER ALL.	
③	PLATED THROUGH HOLE PER 114-13056, FIGURE 4.	
④	1.27 μ m GOLD PER ASTM B 488 IN CONTACT AREA , 1.27 μ m MIN MATTE TIN PER ASTM B 545 ON PCB TAIL, OVER 3.81 μ m MIN NICKEL PER SAE AMS-QQ-N-290 OVER ALL.	

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN 01JUN2000 E. STAHL CHK 01JUN2000 S. MICKLEVIG APP'D 01JUN2000 S. MICKLEVIG		 TE Connectivity	
DIMENSIONS: mm 		TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ±.1 1 PLC ±0.5 2 PLC ±0.13 3 PLC ±.1 4 PLC ±.1 ANGLES: 1 ±0° 2, 4		NAME VERTICAL RECEPTACLE ASSEMBLY, CENTER, FULL, 25.4mm, MultiGig RT-1, BACKPLANE CONNECTOR	
MATERIAL 		FINISH 		SIZE CASE CODE DRAWING NO A100779C=1410210	
		WEIGHT -		RESTRICTED TO -	
		CUSTOMER DRAWING		SCALE 8:1 SHEET 1 OF 1 REV B	